

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3466194

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	
CONVEYING PARTY DATA		
	Name	Execution Date
	JIANMIN MIAO	07/29/2015
RECEIVING PARTY DATA		
Name:	MICROLINK SENSTECH SHANGHAI LTD.	
Street Address:	BUILDING 3 NO. 439 CHUN XIAO ROAD	
Internal Address:	ZHANGJIANG HIGH-TECH PARK, PUDONG NEW AREA	
City:	SHANGHAI 201203	
State/Country:	CHINA	
PROPERTY NUMBERS Total: 1		
	Property Type	Number
	Application Number:	14764811
CORRESPONDENCE DATA		
Fax Number:	(914)723-4301	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>		
Email:	JHART@LSLLP.COM	
Correspondent Name:	ANDREW F. YOUNG, ESQ.	
Address Line 1:	LACKENBACH SIEGEL LLP	
Address Line 2:	ONE CHASE ROAD	
Address Line 4:	SCARSDALE, NEW YORK 10583	
ATTORNEY DOCKET NUMBER:	IPWEL.MP001	
NAME OF SUBMITTER:	ANDREW F. YOUNG	
SIGNATURE:	/AFY/	
DATE SIGNED:	08/03/2015	
Total Attachments: 3		
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source=doc04714320150803091833#page3.tif		

**RECORDATION FORM COVER SHEET
PATENTS ONLY**

To: Commissioner of Patents and Trademarks: Please record the attached original document or copy:

1. Name of conveying party(ies):

JIANMIN MIAO

Additional names? ☐ Yes ☒ No

2. Name and address of receiving party(ies):

Name:

MICROLINK SENSTECH SHANGHAI LTD.

BUILDING 3 NO. 439 CHUN XIAO ROAD

ZHANGJIANG HIGH-TECH PARK

PUDONG NEW AREA

SHANGHAI 201203 CHINA

Additional names & addresses attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger

☐ Security Agreement ☐ Change of Name

☐ Other

Execution Date: 7-29-2015

4. Application number(s) or patent number(s): **14/764,811** DOCKET NO.: **IPWEL.MP001**

If this document is being filed together with a new application, execution date of application is: NA

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence should be mailed: Address associated with **Customer**

No.: 28752

Name: _____

Internal Address: _____

Street Address: _____

City: _____ State: _____ ZIP: _____

6. Total number of applications and patents involved: 1

)

8. ☒ Charge any additional fees in connection with this submission to our Deposit Account No. 10-0100

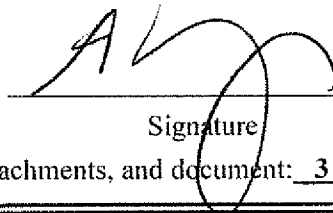
DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

ANDREW F. YOUNG, Reg. No. 44,001

Name of Person Signing



Signature

JULY 31, 2015

Date

Total number of pages including cover sheet, attachments, and document: 3

ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned inventors:

Name	Residence Address
Inventor : MIAO, Jianmin	Building 3 No. 439 Chun Xiao Road, Zhangjiang High-Tech Park, Pudong New Area, Shanghai 201203, China Citizenship: CN

declare that they are citizens of the country indicated above and with the residence as listed above,

Hereby sells, assigns and transfers his undivided interest to MICROLINK SENSTECH SHANGHAI LTD., a corporation of P.R. China, hereafter called the "Assignee," having a place of business at: Building 3 No. 439 Chun Xiao Road, Zhangjiang High-Tech Park, Pudong New Area, Shanghai 201203, China

To their successors, assigns and legal representatives, the entire right, title and interest for the United States and worldwide, in and to any and all improvements which are described and claimed in the

_____ attached specification executed on _____
 _____ specification Serial No. 14/764,811 filed July 30, 2015
 _____ U.S. Letters Patent No. _____ ; issued _____,

entitled: MEMS SILICON MICROPHONE AND MANUFACTURE METHOD THEREOF

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States or worldwide on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States or worldwide on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns and representatives, all facts known to the undersigned relating

Attorney Docket No.: 1PWEL.MP001

to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

DATE July 29, 2015

Jianmin MIAO
MIAO, Jianmin